





































































PCB CAD				
CAD = Computer Aided Drawing	3			
<ul> <li>a PCB CAD tool allows us to enter ou shop can use to create the PCB.</li> </ul>	r design and ultimately produce information that a PCI	B Fab		
- the files that the tool produces are cal	led "Computer Aided Manufacturing (CAM) files.			
- the design flow for PCB CAD consists	s of:			
1) Part Library Development	<ul> <li>A library contains all of the parts in your design. part contains a schematic, a physical layout, and information about the vendor that can be used to a "Build of Materials"</li> </ul>	Each create		
2) Schematic Entry	<ul> <li>A schematic contains all of the part symbols and how they are connected. "Parts" will drive forward the pad configuration in the layout and "nets" will drive forward the traces and plane shapes.</li> </ul>			
3) Layout	<ul> <li>A physical layout is then performed in which all of the parts are placed and connected with traces.</li> </ul>			
4) CAM	<ul> <li>The final step is to create the Gerbers, Drill Files, Drawings to be sent to the fab shop.</li> </ul>	and		
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PCB CAD (Drill Data)				
Drill Data				
- information for drill sizes and locations are contained within a separate set of files.				
- these files are called "Numerically Controlled Drill (NCD) Files" or "Excellon" files.				
- the information in these files is a list of XY coordinates for where each drill hole will be made.				
Ex) for a 4 layer board done in Mentor PADS, we generate				
drill.drl drill.lst drill.rep	: the NCD drill file that is read by the drilling machine : a list of drill coordinates in a user-friendly format for manual checking : a list of all drill sizes in a user-friendly format for manual checking			
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Signal Integrity on PCBs				
Impedance Discontinuities in PCB's				
- sources of impedance discontinuities on PCB's				
1 Vias     2) Pads     3) Cross-talk     4) Return Path     5) Dk variance     6) Etching Tolerance     7) Etching Variance     8) Plating Variance     9) Thickness Variance     - each of these noise sources	(typically larger than the traces we use) (typically larger than the traces we use) (coupling to other traces causes Z <sub>6</sub> to change) (switch routing layers also requires a change in the return (Dk can change from one region of the board to another)) (Trace withis will have tolerances, +/-X <sub>6</sub> , that changes Z <sub>6</sub> (The or withis can change due to eticiting variance across (The thickness of a trace can chance across the board due of the lamination may result in different board thicknesses v a must be analyzed in the noise budget.	path) ) he board) • to plating) 's. location)		
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